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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



 WAVESHARE share awesome hardware	EPAPER SPECIFICATIONS	SPEC NO	
	2.7" e-Paper (B)	REV NO	

e-Paper Display Specifications



Waveshare Electronics

Waveshare Electronics Room 813, Dynamic World Building,
Zhenhua Rd, Futian District, Shenzhen China

Website: www.waveshare.com

Product Specification**Revision History**

Rev.	Issued Date	Revised Contents
1.0	Sep.10.2015	Preliminary
1.1	Oct.15.2015	1. In part 6: Delete command 70h.
1.2	Nov.03.2015	1. In part 14: Add packing. 2. In part 5-1): Modify pin out list. 3. In part 7-5): Modify reference circuit. 4. In part 8: Modify typical operating sequence. 5. In part 11: Modify T=+40°C, RH=90% for 1000 hrs to T=+40°C, RH=80% for 240 hrs.

Product Specification***TECHNICAL SPECIFICATION******CONTENTS***

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Product Specification

1. Over View

The display is a TFT active matrix electrophoretic display, with interface and a reference system design. The 2.7" active area contains 264×176 pixels, and has 1-bit white/black and 1-bit red full display capabilities. An integrated circuit contains gate buffer, source buffer, interface, timing control logic, oscillator, DC-DC, SRAM, LUT, VCOM and border are supplied with each panel.

2. Features

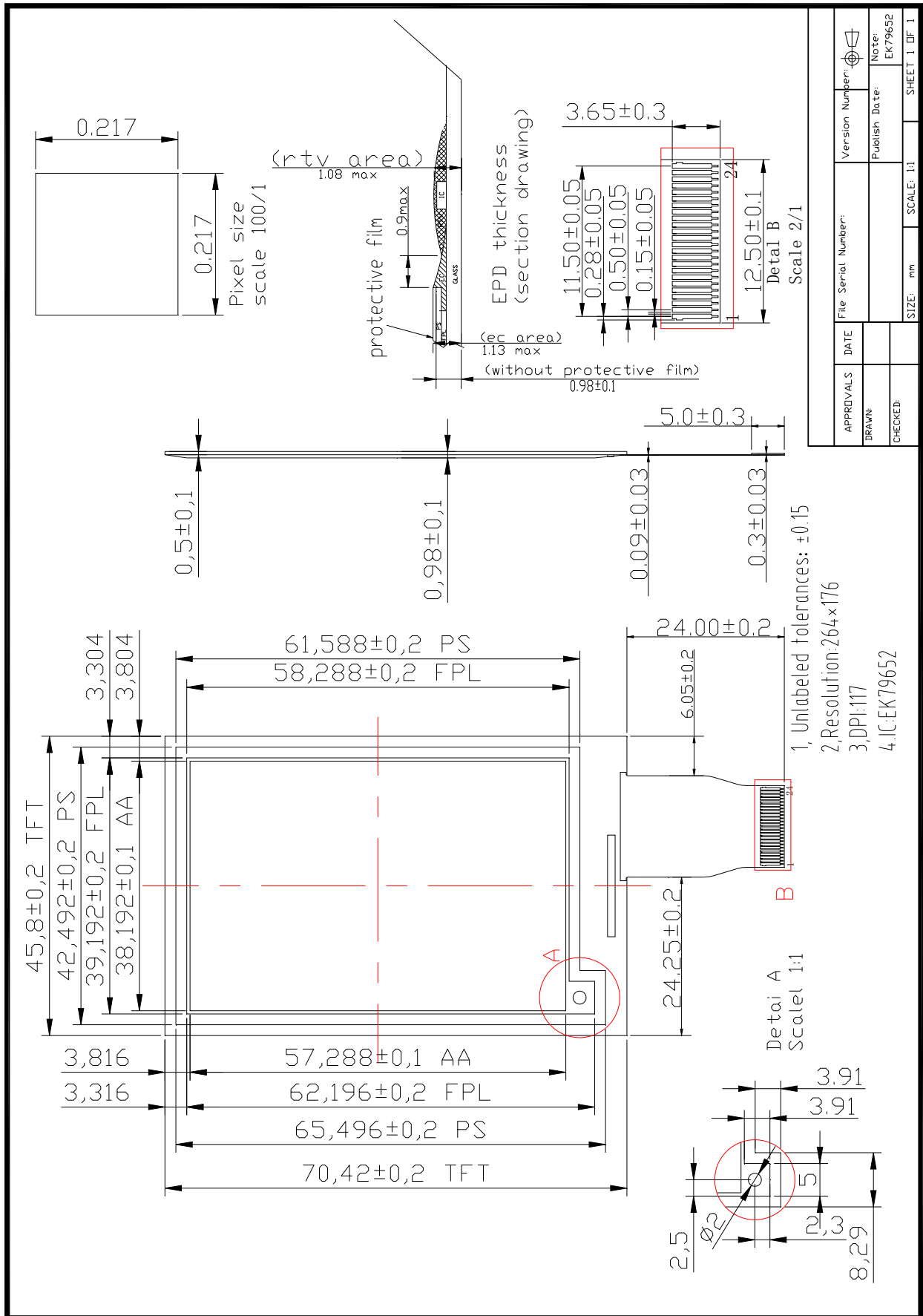
- High contrast
- High reflectance
- Ultra wide viewing angle
- Ultra low power consumption
- Pure reflective mode
- Bi-stable
- Commercial temperature range
- Landscape, portrait mode
- Antiglare hard-coated front-surface
- Low current sleep mode
- On chip display RAM
- Waveform stored in On-chip OTP
- Serial peripheral interface available
- On-chip oscillator
- On-chip booster and regulator control for generating VCOM, Gate and source driving voltage
- I²C Signal Master Interface to read external temperature sensor
- Available in COG package IC thickness 280um

3. Mechanical Specifications

Parameter	Specifications	Unit	Remark
Screen Size	2.7	Inch	
Display Resolution	264(H) × 176(V)	Pixel	Dpi: 117
Active Area	57.288(H) × 38.192(V)	mm	
Pixel Pitch	0.217 × 0.217	mm	
Pixel Configuration	Rectangle		
Outline Dimension	70.42(H) × 45.8(V) × 0.98(D)	mm	
Weight	6.08 ± 0.5	g	

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4. Mechanical Drawing of EPD module



APPROVALS	DATE	File Serial Number:	Version Number:
DRAWN			
CHECKED		Publish Date:	Note: EK79652
		SIZE: mm	SCALE: 1:1
			SHEET 1 OF 1

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5. Input/Output Terminals

5-1) Pin out List

Pin #	Type	Single	Description	Remark
1		NC	No connection and do not connect with other NC pins	Keep Open
2	O	GDR	This pin is N-MOS gate control	
3	P	RESE	Current Sense Input for the Control Loop	
4	P	VSLR	Negative source voltage for Red	
5	P	VSL	Negative source voltage	
6	O	TSCL	I ² C clock for external temperature sensor	
7	I/O	TSDA	I ² C data for external temperature sensor	
8	I	BS	Input interface setting	Note 5-5
9	O	BUSY_N	This pin indicates the driver status	Note 5-4
10	I	RST_N	Reset	Note 5-3
11	I	DC	Serial communication Command / Data input	Note 5-2
12	I	CSB	Serial communication chip Select	Note 5-1
13	I	SCL	Serial communication clock input	
14	I/O	SDA	Serial communication date input	
15	P	VDDIO	I/O voltage supply	
16	P	VDD	Digital/Analog power	
17	P	VSS	Digital ground	
18	P	VDD	Voltage input & output	
19	P	VOTP	OTP Program power	
20	P	VSH	Positive Source voltage	
21	P	VGH	Positive gate voltage	
22	P	VSHR	Positive Source voltage for Red	
23	P	VGL	Negative gate voltage	
24	O	VCOM	VCOM output	

Note 5-1: This pin (CSB) is the chip select input connecting to the MCU. The chip is enabled for MCU communication only when CSB is pulled Low.

Note 5-2: This pin (DC) is Data/Command control pin connecting to the MCU. When the pin is pulled High, the data will be interpreted as data. When the pin is pulled Low, the data will be interpreted as command.

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Note 5-3: This pin (RST_N) is reset signal input. The Reset is active Low.

Note 5-4: This pin (BUSY_N) is BUSY_N state output pin. When BUSY_N is Low the operation of chip should not be interrupted and any commands should not be issued to the module. The driver IC will put BUSY_N pin Low when the driver IC is working such as:

- Outputting display waveform; or
- Programming with OTP
- Communicating with digital temperature sensor

Note 5-5: This pin (BS) is for 3-line SPI or 4-line SPI selection. When it is “Low”, 4-line SPI is selected. When it is “High”, 3-line SPI (9 bits SPI) is selected. Please refer to below Table.

Table: Bus interface selection

BS	MPU Interface
L	4-lines serial peripheral interface (SPI)
H	3-lines serial peripheral interface (SPI) – 9 bits SPI

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6. Command Table

W/R: 0: Write cycle 1: Read cycle C/D: 0: Command 1: Data D7~D0: -: Don't care #: Valid Data

#	Command	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0	Registers	Default	
1	Panel Setting(PSR)	0	0	0	0	0	0	0	0	0	0		00h	
		0	1	#	#	#	#	#	#	#	#	#	ES[1],RES[0],LUT_EN,BWR, UD,SHL, SHD_N,RST_N	07h
2	Power setting (PWR)	0	0	0	0	0	0	0	0	0	1		01h	
		0	1	-	-	-	-	-	-	#	#	#	VDS_EN, VDG_EN	03h
		0	1	-	-	-	-	-	-	#	#	#	VCOM_HV,VGHL_LV[1],VGHL_LV[0]	20h
		0	1	-	-	#	#	#	#	#	#	#	VDH[5:0]	26h
		0	1	-	-	#	#	#	#	#	#	#	VDL[5:0]	26h
		0	1	-	-	#	#	#	#	#	#	#	VDHR[5:0]	03h
3	Power OFF(POF)	0	0	0	0	0	0	0	0	1	0		02h	
4	Power OFF	0	0	0	0	0	0	0	0	1	1		03h	
	Sequence Setting (PFS)	0	1	-	-	#	#	-	-	-	-	T_VDS_OFF[1:0]	00h	
5	Power ON(PON)	0	0	0	0	0	0	0	1	0	0		04h	
6	Power ON Measure (PMES)	0	0	0	0	0	0	0	1	0	1		05h	
7	Booster Soft Start (BTST)	0	0	0	0	0	0	0	1	1	0		06h	
		0	1	#	#	#	#	#	#	#	#	#	BT_PHA[7:0]	03h
		0	1	#	#	#	#	#	#	#	#	#	BT_PHB[7:0]	00h
		0	1	-	-	#	#	#	#	#	#	#	BT_PHC[5:0]	26h
8	Deep Sleep	0	0	0	0	0	0	0	1	1	1		07h	
		0	1	1	0	1	0	0	1	0	1		A5h	
9	Data Start	0	0	0	0	0	1	0	0	0	0		10h	
	Transmission 1 (DTM1)	0	1	#	#	#	#	#	#	#	#		00h	
10	Data Stop(DSP)	0	0	0	0	0	1	0	0	0	1		11h	
		1	1	#	-	-	-	-	-	-	-	Data_flag	00h	
11	Display Refresh (DRF)	0	0	0	0	0	1	0	0	1	0		12h	
12	Data start transmission	0	0	0	0	0	1	0	0	1	1		13h	
	2(DTM2)	0	1	#	#	#	#	#	#	#	#		00h	
13	Partial Data Start	0	0	0	0	0	1	0	1	0	0		14h	
	transmission 1(PDTM1)	0	1	#	#	#	#	#	#	#	#		00h	

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#	Command	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0	Registers	Default	
14	Partial Data Start transmission2(PDTM2)	0	0	0	0	0	1	0	1	0	1		15h	
		0	1	#	#	#	#	#	#	#	#	#		00h
15	Partial Display Refresh (PDRF)	0	0	0	0	0	1	0	1	1	0		16h	
		0	1	#	#	#	#	#	#	#	#	#		00h
16	LUT for VCOM(LUT1)	0	0	0	0	1	0	0	0	0	0		20h	
17	White to white LUT (LUTWW)	0	0	0	0	1	0	0	0	0	1		21h	
18	Black to white LUT (LUTBW/LUTR)	0	0	0	0	1	0	0	0	1	0		22h	
19	White to Black LUT (LUTWB/LUTW)	0	0	0	0	1	0	0	0	1	1		23h	
20	Black to Black LUT (LUTBB/LUTB)	0	0	0	0	1	0	0	1	0	0		24h	
21	PLL control(PLL)	0	0	0	0	1	1	0	0	0	0		30h	
		0	1	-	#	#	#	#	#	#	#	#	SEL_DIV[1:0], SEL_F[4:0]	3Ch
22	Temperature Sensor Command (TSC)	0	0	0	1	0	0	0	0	0	0		40h	
		1	1	#	#	#	#	#	#	#	#	#	D[10:3]/TS[7:0]	00h
		1	1	#	#	#	-	-	-	-	-	-	D[2:0]/-	00h
23	Temperature Sensor Calibration (TSE)	0	0	0	1	0	0	0	0	0	1		41h	
		0	1	#	-	-	-	#	#	#	#	#	TSE,TO[3:0]	00h
24	Temperature Sensor Write (TSW)	0	0	0	1	0	0	0	0	1	0		42h	
		0	1	#	#	#	#	#	#	#	#	#	WATTR[7:0]	00h
		0	1	#	#	#	#	#	#	#	#	#	WMSB[7:0]	00h
		0	1	#	#	#	#	#	#	#	#	#	WLSB[7:0]	00h
25	Temperature Sensor Read (TSR)	0	0	0	1	0	0	0	0	1	1		43h	
		1	1	#	#	#	#	#	#	#	#	#	RMSB[7:0]	00h
		1	1	#	#	#	#	#	#	#	#	#	RLSB[7:0]	00h
26	Vcom and Data interval setting (CDI)	0	0	0	1	0	1	0	0	0	0		50h	
		0	1	#	#	#	#	#	#	#	#	#	VBD[1:0],DDX[1:0],CDI[3:0]	D7h
27	Low power Detection (LPD)	0	0	0	1	0	1	0	0	0	1		51h	
		1	1	-	-	-	-	-	-	-	-	LPD		-
28	TCON Setting (TCON)	0	0	0	1	1	0	0	0	0	0		60h	
		0	1	#	#	#	#	#	#	#	#	#	S2G[3:0],G2S[3:0]	22h
29	TCON resolution (TRES)	0	0	0	1	1	0	0	0	0	1		61h	
		0	1	-	-	-	-	-	-	-	-	#	HRES[8]	00h
		0	1	#	#	#	#	#	#	#	#	-	HRES[7:1]	00h
		0	1	-	-	-	-	-	-	-	-	#	VRES[8]	00h
		0	1	#	#	#	#	#	#	#	#	#	VRES[7:0]	00h

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#	Command	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0	Registers	Default	
30	Source & gate start setting	0	0	0	1	1	0	0	0	1	0		62h	
		0	1	-	-	-	-	-	-	-	-	#	S_start[8]	00h
		0	1	#	#	#	#	#	#	#	#	#	S_start[7:0]	00h
		0	1	-	-	-	#	-	-	-	-	#	gscan, G_start[8]	00h
		0	1	#	#	#	#	#	#	#	#	#	G_start[7:0]	00h
31	Get Status (FLG)	0	0	0	1	1	1	0	0	0	1		71h	
		1	1	-	-	#	#	#	#	#	#	I ² C_ERR, I ² C_BUSY_N, Data_flag, PON, POF, BUSY_N	02h	
32	Auto Measure Vcom (AMV)	0	0	1	0	0	0	0	0	0	0		80h	
		1	1	-	-	#	#	#	#	#	#	AMV[1:0], XON, AMVS, AMV, AMVE	10h	
33	Vcom Value (VV)	0	0	1	0	0	0	0	0	0	1		81h	
		0	1	-	#	#	#	#	#	#	#	VV[6:0]	00h	
34	VCM_DC Setting register (VDCS)	0	0	1	0	0	0	0	0	1	0		82h	
		0	1	-	#	#	#	#	#	#	#	VDCS[6:0]	00h	
35	Program Mode(PGM)	0	0	1	0	1	0	0	0	0	0		A0h	
		0	1	1	0	1	0	0	1	0	1		A5h	
36	Active Program(APG)	0	0	1	0	1	0	0	0	0	1		A1h	
37	Read OTP Data(ROTP)	0	0	1	0	1	0	0	0	1	0		A2h	
		1	1	#	#	#	#	#	#	#	#		-	

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(1) Panel Setting (PSR) (Register: R00H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Setting the panel	0	0	0	0	0	0	0	0	0	0
	0	1	RES1	RES0	LUT_EN	BWR	UD	SHL	SHD_N	RST_N

RES[1:0]: Display resolution setting (source × gate)

00b: 320 × 300 (default)

01b: 300 × 200

10b: 296 × 160

11b: 296 × 128

LUT_EN: LUT selection setting.

0: Using LUT from OTP. (default)

1: Using LUT from register.

BWR: Color selecting setting.

0: Pixel with B/W/Red. Run both LU1 and LU2. (default)

1: Pixel with B/W. Run LU1 only.

UD: Gate Scan Direction

0: Scan down First line to last: Gn → ... → G1 (default)

1: Scan up. (default) First line to last: G1 → ... → Gn

SHL: Source shift direction

0: shift left. First data to last data: Sn → ... → S1

1: shift right First data to last data: S1 → ... → Sn (default)

SHD_N: Booster switch

0: Booster OFF, register data are kept, and SEG/BG/VCOM are kept floating.

1: Booster ON (default)

When SHD_N become low, DC-DC will turn OFF. Register and SRAM data will keep until VDD OFF. SD output and VCOM will base on previous condition and keep floating.

RST_N: Soft Reset

0: No effect.

1: Booster OFF, Register data are set to their default values, and SEG/BG/VCOM: 0V. (default)

When RST_N become low, driver will reset. All register will reset to default value. Driver all function will disable. SD output and VCOM will base on previous condition and keep floating.

(2) Power Setting Register (R01H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Selecting Internal/External Power	0	0	0	0	0	0	0	0	0	1
	0	1	-	-	-	-	-	-	VDS_EN	VDG_EN
	0	1	-	-	-	-	-	VCOM_HV	VGHL_LV[1:0]	
	0	1	-	-	VDH[5:0]					
	0	1	-	-	VDL[5:0]					
	0	1	-	-	VDHR[5:0]					

VDS_EN: Source power selection

0: External source power from VDH/VDL pins

1: Internal DC/DC function for generate VDH/VDL

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VDG_EN: Gate power selection

0: External VDNS power from VGH/VGL pins. (VDNG_EN open)

1: Internal DC/DC function for generate VGH/VGL.

VCOM_HV: VCOM Voltage Level

0: VCOMH=VDH+VCOMDC, VCOML=VHL+VCOMDC

1: VCOML=VGH, VCOML=VGL

VGHL_LV[1:0]: VGH / VGL Voltage Level selection.

VGHL_LV	VGHL voltage level
00(Default)	VGH=16V,VGL= -16V
01	VGH=15V,VGL= -15V
10	VGH=14V,VGL= -14V
11	VGH=13V,VGL= -13V

VDH[5:0]: Internal VDH power selection for B/W pixel.(Default value: 100110b)

VDH	VDH_V	VDH	VDH_V
000000	2.4V
000001	2.6V	100110	10.0V
000010	2.8V	100111	10.2V
000011	3.0V	101000	10.4V
000100	3.2V	101001	10.6V
000101	3.4V	101010	10.8V
000110	3.6V	101011	11.0V
000111	3.8V	(others)	11.0V

VDL[5:0]: Internal VDL power selection for B/W pixel. (Default value: 100110b)

VDL	VDL_V	VDL	VDL_V
000000	-2.4V
000001	-2.6V	100110	-10.0V
000010	-2.8V	100111	-10.2V
000011	-3.0V	101000	-10.4V
000100	-3.2V	101001	-10.6V
000101	-3.4V	101010	-10.8V
000110	-3.6V	101011	-11.0V
000111	-3.8V	(others)	-11.0V

VDHR[5:0]: Internal VDHR power selection for Red pixel. (Default value: 000011b)

VDHR	VDHR_V	VDHR	VDHR_V
000000	2.4V
000001	2.6V	100110	10.0V
000010	2.8V	100111	10.2V
000011	3.0V	101000	10.4V
000100	3.2V	101001	10.6V
000101	3.4V	101010	10.8V
000110	3.6V	101011	11.0V
000111	3.8V	(others)	11.0V

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(3) Power OFF (PWR) (R02H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Turning OFF the power	0	0	0	0	0	0	0	0	1	0

After the Power Off command, the driver will power off following the Power Off Sequence.

After the Power Off command, BUSY_N signal will drop from high to low. When finish the power off sequence, BUSY_N signal will rise from low to high.

This command will turn off charge pump, T-con, source driver, gate driver, VCOM, and temperature sensor, but register data and SRAM data will kept until VDD OFF.

Source Driver output and Vcom will base on previous condition, which may have 2 condition: 0V or floating.

(4) Power OFF Sequence Setting (R03H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Setting Power OFF Sequence	0	0	0	0	0	0	0	0	1	1
	0	1	-	-	Vsh_off[1:0]		Vsl_off[1:0]		Vshr_off[1:0]	

Vshr_off[1:0]: 00: 5 ms (Default) 01: 10 ms 10: 20 ms 11: 40 ms

Vsl_off[1:0]: 00: 5 ms (Default) 01: 10 ms 10: 20 ms 11: 40 ms

Vsh_off[1:0]: 00: 5 ms (Default) 01: 10 ms 10: 20 ms 11: 40 ms

(5) Power ON (R04H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Turning ON the Power	0	0	0	0	0	0	0	1	0	0

After the Power ON command, driver will power on based on the Power ON Sequence.

After Power On command, BUSY_N signal will drop from high to low. When finishing the power off sequence, BUSY_N signal will rise from low to high.

(6) Power ON Measure (PMES) (R05H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
	0	0	0	0	0	0	0	0	1	0

If user want to read temperature sensor or detect low power in power off mode, user has to send this command. After power on measure command, driver will switch on relevant commend with Low Power detection (R51H) and temperature measurement. (R40H).

(7) Booster Soft Start (BTST) (R06H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Starting data transmission	0	0	0	0	0	0	0	1	1	0
	0	1	BT_PHA7	BT_PHA6	BT_PHA5	BT_PHA4	BT_PHA3	BT_PHA2	BT_PHA1	BT_PHA0
	0	1	BT_PHB7	BT_PHB6	BT_PHB5	BT_PHB4	BT_PHB3	BT_PHB2	BT_PHB1	BT_PHB0
	0	1	-	-	BT_PHC5	BT_PHC4	BT_PHC3	BT_PHC2	BT_PHC1	BT_PHC0

BTPHA[7:6]: Soft start period of phase A.

00b: 10mS 01b: 20mS 10b: 30mS 11b: 100mS

BTPHA[5:3]: Driving strength of phase A

000b: strength 1 001b: strength 2 **010b: strength 3** 011b: strength 4

100b: strength 5 101b: strength 6 110b: strength 7 111b: strength 8 (strongest)

BTPHA[2:0]: Minimum OFF time setting of GDR in phase B

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	000b: 0.27uS	001b: 0.34uS	010b: 0.40uS	011b: 0.54uS
	100b: 0.80uS	101b: 1.54uS	110b: 3.34uS	111b: 6.58uS
BTPHB[7:6]:	Soft start period of phase B.			
	00b: 10mS	01b: 20mS	10b: 30mS	11b: 100mS
BTPHB[5:3]:	Driving strength of phase B			
	000b: strength 1	001b: strength 2	010b: strength 3	011b: strength 4
	100b: strength 5	101b: strength 6	110b: strength 7	111b: strength 8 (strongest)
BTPHB[2:0]:	Minimum OFF time setting of GDR in phase B			
	000b: 0.27uS	001b: 0.34uS	010b: 0.40uS	011b: 0.54uS
	100b: 0.80uS	101b: 1.54uS	110b: 3.34uS	111b: 6.58uS
BTPHC[5:3]:	Driving strength of phase C			
	000b: strength 1	001b: strength 2	010b: strength 3	011b: strength 4
	100b: strength 5	101b: strength 6	110b: strength 7	111b: strength 8 (strongest)
BTPHC[2:0]:	Minimum OFF time setting of GDR in phase C			
	000b: 0.27uS	001b: 0.34uS	010b: 0.40uS	011b: 0.54uS
	100b: 0.80uS	101b: 1.54uS	110b: 3.34uS	111b: 6.58uS

(8) Deep Sleep (DSLPL) (R07H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Deep Sleep	0	0	0	0	0	0	0	1	1	1
	0	1	1	0	1	0	0	1	0	1

After this command is transmitted, the chip would enter the deep-sleep mode to save power.

The deep sleep mode would return to standby by hardware reset.

The only one parameter is a check code, the command would be executed if check code = 0xA5.

(9) Data Start Transmission 1 (R10H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Starting data transmission	0	0	0	0	0	1	0	0	0	0
	0	1	Pixel1	Pixel2	Pixel3	Pixel4	Pixel5	Pixel6	Pixel7	Pixel8
	0	1
	0	1	Pixel(n-7)	Pixel(n-6)	Pixel(n-5)	Pixel(n-4)	Pixel(n-3)	Pixel(n-2)	Pixel(n-1)	Pixel(n)

The register indicates that user start to transmit data, then write to SRAM. While data transmission complete, user must send command 11H. Then chip will start to send data/VCOM for panel.

In B/W mode, this command writes "OLD" data to SRAM.

In B/W/Red mode, this command writes "B/W" data to SRAM.

(10) Data stop (R11H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Stopping data transmission	0	0	0	0	0	1	0	0	0	1
	1	1	data_flag	-	-	-	-	-	-	-

While finished the data transmitting, user must send this command to driver and read Data_flag information.

Data_flag: Data flag of receiving user data.

0: Driver didn't receive all the data.

Product Specification

1: Driver has already received all the one-frame data (DTM1 and DTM2).

After “Data Start” (10h) or “Data Stop” (11h) commands and when data_flag=1, BUSY_N signal will become “0” and the refreshing of panel starts. This command only actives when BUSY_N = “1”.

(11) Display Refresh Command (R12H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Refreshing the display	0	0	0	0	0	1	0	0	1	0

After this command is issued, driver will refresh display (data/VCOM) according to SRAM data and LUT. After Display Refresh command, BUSY_N signal will become “0”.

This command only active when BUSY_N = “1”.

(12) Data start transmission 2 register (R13H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Data start transmission 2 (DTM2)	0	0	0	0	0	1	0	0	1	0
	0	1	Kpixel1	Kpixel2	Kpixel3	Kpixel4	Kpixel5	Kpixel6	Kpixel7	Kpixel8
	0	1
	0	1	Kpixel(n-7)	Kpixel(n-6)	Kpixel(n-5)	Kpixel(n-4)	Kpixel(n-3)	Kpixel(n-2)	Kpixel(n-1)	Kpixel(n)

The register is indicates that user start to transmit data, then write to SRAM. While data transmission complete, user must send command 11H. Then chip will start to send data/VCOM for panel.

In B/W mode, this command writes “NEW” data to SRAM.

In B/W/Red mode, this command writes “RED” data to SRAM.

(13) Partial Data Start transmission 1 register (R14h)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Partial Data Start transmission 1	0	0	0	0	0	1	0	1	0	0
	0	1	-	-	-	-	-	-	-	X[8]
	0	1	X[7]	X[6]	X[5]	X[4]	X[3]	0	0	0
			-	-	-	-	-	-	-	Y[8]
	0	1	Y[7]	Y[6]	Y[5]	Y[4]	Y[3]	Y[2]	Y[1]	Y[0]
	0	1	-	-	-	-	-	-	-	W[8]
	0	1	W[7]	W[6]	W[5]	W[4]	W[3]	0	0	0
			-	-	-	-	-	-	-	L[8]
	0	1	L[7]	L[6]	L[5]	L[4]	L[3]	L[2]	L[1]	L[0]
	0	1	Kpixel1	Kpixel2	Kpixel3	Kpixel4	Kpixel5	Kpixel6	Kpixel7	Kpixel8
	0	1
0	1	Kpixel(n-7)	Kpixel(n-6)	Kpixel(n-5)	Kpixel(n-4)	Kpixel(n-3)	Kpixel(n-2)	Kpixel(n-1)	Kpixel(n)	

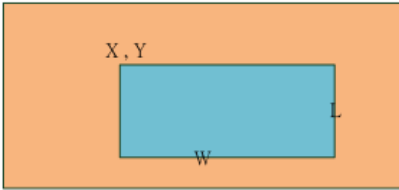
The command define as follows: The register is indicates that user start to transmit data, then write to SRAM. While data transmission complete, user must send command 11H. Then chip will start to send data/VCOM for panel.

In B/W mode, this command writes “OLD” data to SRAM.

Product Specification

In B/W/Red mode, this command writes “B/W” data to SRAM.

Partial update location and area



Note: X and W should be the multiple of 8.

(14) Partial Data Start transmission 2 register (R15h)

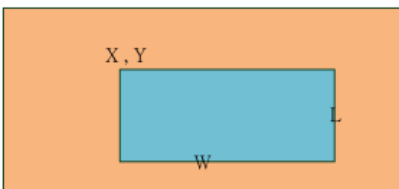
Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Partial Data Start transmission 2	0	0	0	0	0	1	0	1	0	1
	0	1	-	-	-	-	-	-	-	X[8]
	0	1	X[7]	X[6]	X[5]	X[4]	X[3]	0	0	0
			-	-	-	-	-	-	-	Y[8]
	0	1	Y[7]	Y[6]	Y[5]	Y[4]	Y[3]	Y[2]	Y[1]	Y[0]
	0	1	-	-	-	-	-	-	-	W[8]
	0	1	W[7]	W[6]	W[5]	W[4]	W[3]	0	0	0
			-	-	-	-	-	-	-	L[8]
	0	1	L[7]	L[6]	L[5]	L[4]	L[3]	L[2]	L[1]	L[0]
	0	1	Kpixel1	Kpixel2	Kpixel3	Kpixel4	Kpixel5	Kpixel6	Kpixel7	Kpixel8
	0	1
	0	1	Kpixel(n-7)	Kpixel(n-6)	Kpixel(n-5)	Kpixel(n-4)	Kpixel(n-3)	Kpixel(n-2)	Kpixel(n-1)	Kpixel(n)

The command define as follows: The register is indicates that user start to transmit data, then write to SRAM. While data transmission complete, user must send command 11H. Then chip will start to send data/VCOM for panel.

In B/W mode, this command writes “NEW” data to SRAM.

In B/W/Red mode, this command writes “RED” data to SRAM.

Partial update location and area



Note: X and W should be the multiple of 8.

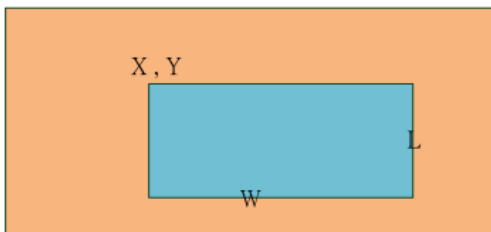
Product Specification

(15) Partial Display Refresh Command (R16h)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Partial Display Refresh	0	0	0	0	0	1	0	1	1	0
	0	1	DFV_EN							X[8]
	0	1	X[7]	X[6]	X[5]	X[4]	X[3]	0	0	0
										Y[8]
	0	1	Y[7]	Y[6]	Y[5]	Y[4]	Y[3]	Y[2]	Y[1]	Y[0]
	0	1								W[8]
	0	1	W[7]	W[6]	W[5]	W[4]	W[3]	W[2]	W[1]	W[0]
										L[8]
	0	1	L[7]	L[6]	L[5]	L[4]	L[3]	L[2]	L[1]	L[0]

While user sent this command, driver will refresh display (data/VCOM) base on SRAM data and LUT.

Only the area (X,Y, W, L) would update, the others pixel output would follow VCOM LUT After display refresh command, BUSY_N signal will become "0".



Note: X and W should be the multiple of 8.

DFV_EN: data follow VCOM function on display area.

DFV_EN=1: Only effective in B/W mode, if pixel from "New data" SRAM equal to "Old data" SRAM on display area, this pixel output would follow VCOM LUT.

DFV_EN=0: Data doesn't follow VCOM LUT.

This command only active when BUSY_N = "1".

(16) VCOM LUT (LUTC) (R20H)

This command builds Look-up Table for VCOM

(17) W2W LUT (LUTWW) (R21H)

This command builds Look-up Table for White-to-White.

(18) B2W LUT (LUTBW/LUTR) (R22H)

This command builds Look-up Table for Black-to-White.

(19) W2B LUT (LUTWB/LUTW) (R23H)

This command builds Look-up Table for White - to- Black.

(20) B2B LUT (LUTBB / LUTB) (R24H)

This command builds Look-up Table for Black - to- Black.

Product Specification

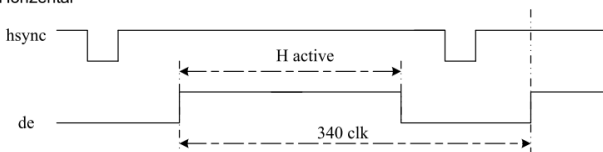
(21) PLL Control (R30H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Controlling PLL	0	0	0	0	1	1	0	0	0	0
	0	1	-	SEL_DIV[1:0]		SEL_F[4:0]				

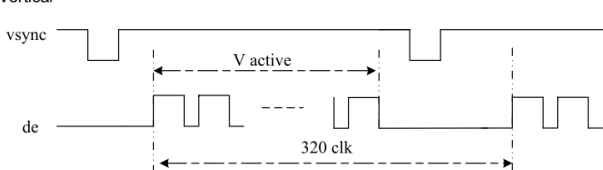
The command controls the PLL clock frequency. The PLL structure must support the following frame rates:

SEL_F[5:0]	SEL_DIV[1:0]				SEL_F[5:0]	SEL_DIV[1:0]			
	00	01	10	11		00	01	10	11
000000	156.25	78.13	39.06	-	100000	153.49	76.75	38.37	-
000001	159.01	79.5	39.75	-	100001	150.74	75.37	37.68	-
000010	161.76	80.88	40.44	20.22	100010	147.98	73.99	36.99	-
000011	164.52	82.26	41.13	20.57	100011	145.22	72.61	36.31	-
000100	167.28	83.64	41.82	20.91	100100	142.46	71.23	35.62	-
000101	170.04	85.02	42.51	21.25	100101	139.71	69.85	34.93	-
000110	172.79	86.4	43.2	21.6	100110	136.95	68.47	34.24	-
000111	175.55	87.78	43.89	21.94	100111	134.19	67.1	33.55	-
001000	178.31	89.15	44.58	22.29	101000	131.43	65.72	32.86	-
001001	181.07	90.53	45.27	22.63	101001	128.68	64.34	32.17	-
001010	183.82	91.91	45.96	22.98	101010	125.92	62.96	31.48	-
001011	186.58	93.29	46.65	23.32	101011	123.16	61.58	30.79	-
001100	189.34	94.67	47.33	23.67	101100	120.4	60.2	30.1	-
001101	192.1	96.05	48.02	24.01	101101	117.65	58.82	29.41	-
001110	194.85	97.43	48.71	24.36	101110	114.89	57.44	28.72	-
001111	197.61	98.81	49.4	24.7	101111	112.13	56.07	28.03	-
010000	-	100.18	50.09	25.05	110000	109.38	54.69	27.34	-
010001	-	101.56	50.78	25.39	110001	106.62	53.31	26.65	-
010010	-	102.94	51.47	25.74	110010	103.86	51.93	25.97	-
010011	-	104.32	52.16	26.08	110011	101.1	50.55	25.28	-
010100	-	105.7	52.85	26.42	110100	98.35	49.17	24.59	-
010101	-	107.08	53.54	26.77	110101	95.59	47.79	23.9	-
010110	-	108.46	54.23	27.11	110110	92.83	46.42	23.21	-
010111	-	109.83	54.92	27.46	110111	90.07	45.04	22.52	-
011000	-	111.21	55.61	27.8	111000	87.32	43.66	21.83	-
011001	-	112.59	56.3	28.15	111001	84.56	42.28	21.14	-
011010	-	113.97	56.99	28.49	111010	81.8	40.9	20.45	-
011011	-	115.35	57.67	28.84	111011	79.04	39.52	-	-
011100	-	116.73	58.36	29.18	111100	76.29	38.14	-	-
011101	-	118.11	59.05	29.53	111101	73.53	36.76	-	-
011110	-	119.49	59.74	29.87	111110	70.77	35.39	-	-
011111	-	120.86	60.43	30.22	111111	68.01	34.01	-	-

-Horizontal



-Vertical



Product Specification

(22) Temperature Sensor Calibration (R40H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Sensing Temperature	0	0	0	1	0	0	0	0	0	0
	1	1	D10	D9/TS6	D8/TS5	D7/TS4	D6/TS3	D5/TS2	D4/TS1	D3/TS0
	1	1	D2	D1	D0	-	-	-	-	-

This command reads the temperature sensed by the temperature sensor.

TS[7:0]: When TSE (R41h) is set to 0, this command reads internal temperature sensor value.

D[10:0]: When TSE (R41h) is set to 1, this command reads external LM75 temperature sensor value.

(23) Temperature Sensor Calibration (R41H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Calibrate Temperature Sensor	0	0	0	1	0	0	0	0	0	1
	0	1	TSE	-	-		TO[3:0]			

This command selects Internal or External temperature sensor.

TSE: Internal temperature sensor switch

0: Enable (default)

1: Disable; using external sensor.

TO[3:0]: Temperature offset.

TO[3]: sign bit 0b: + 1b: -

TO[2:0]: offset value

TO[3:0]	Calculation	TO[3:0]	Calculation
0000 b	0	1000	-8
0001	1	1001	-7
0010	2	1010	-6
...
0110	6	1110	-2
0111	7	1111	-1

(24) Temperature Sensor Write (TSW) (R42H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Write External Temperature Sensor	0	0	0	1	0	0	0	0	1	0
	0	1	WATTR[7:0]							
	0	1	WMSB[7:0]							
	0	0	WLSB[7:0]							

This command reads the temperature sensed by the temperature sensor.

WATTR: D[7:6]: $^{\circ}$ C Write Byte Number

00b : 1 byte (head byte only)

01b : 2 bytes (head byte + pointer)

10b : 3 bytes (head byte + pointer + 1st parameter)

11b : 4 bytes (head byte + pointer + 1st parameter + 2nd parameter)

D[5:3]: User-defined address bits (A2, A1, A0)

D[2:0]: Pointer setting

WMSB[7:0]: MSByte of write-data to external temperature sensor.

Product Specification

WLSB[7:0]: LSByte of write-data to external temperature sensor.

This command only actives after R04H(PON) or R05H(PMES).

(25) Temperature Sensor Read (TSR) (R43H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Read External Temperature Sensor	0	0	0	1	0	0	0	0	1	1
	1	1	RMSB[7:0]							
	1	1	RLSB[7:0]							

This command reads the temperature sensed by the temperature sensor.

RMSB[7:0]: MSByte read data from external temperature sensor.

RLSB[7:0]: LSByte read data from external temperature sensor.

This command only actives after R04H(PON) or R05H(PMES).

(26) VCOM and Data Interval Setting (R50H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Set Interval between Vcom and Data	0	0	0	1	0	1	0	0	0	0
	0	1	VBD[1:0]		DDX[1:0]		CDI[3:0]			

This command indicates the interval of Vcom and data output. When setting the vertical back porch, the total blanking will be kept (20 Hsync).

VBD[1:0]: Border data selection

B/W/Red mode (BWR=0)

DDX[0]	VBD[1:0]	LUT	DDX[0]	VBD[1:0]	LUT
0	00	Floating	1(Default)	00	LUTB
	01	LUTR		01	LUTW
	10	LUTW		10	LUTR
	11	LUTB		11(default)	Floating

B/W mode (BWR=1)

DDX[0]	VBD[1:0]	LUT	DDX[0]	VBD[1:0]	LUT
0	00	Floating	1(Default)	00	Floating
	01	LUTBW (1→0)		01	LUTWB (1→0)
	10	LUTWB (0→1)		10	LUTBW (0→1)
	11	Floating		11	Floating

DDX[1:0]: Data polarity.

DDX[1] for RED data, DDX[0] for BW data in the B/W/Red mode.

DDX[0] for B/W mode.

B/W/Red mode (BWR=0)

DDX[1:0]	Data {Red, B/W}	LUT	DDX[1:0]	Data {Red, B/W}	LUT
00	00	LUTW	10	00	LUTR
	01	LUTB		01	LUTR
	10	LUTR		10	LUTW
	11	LUTR		11	LUTB

Product Specification

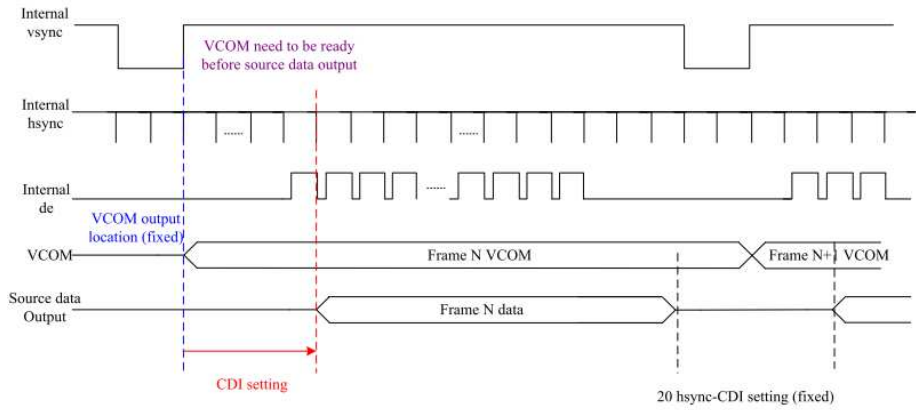
01(Default)	00	LUTB	11	00	LUTR
	01	LUTW		01	LUTR
	10	LUTR		10	LUTB
	11	LUTR		11	LUTW

B/W mode (BWR=1)

DDX[0]	Data {New, Old}	LUT		DDX[0]	Data {New, Old}	LUT
0	00	LUTWW (0→0)	1(Default)	00	LUTBB (0→0)	
	01	LUTBW (1→0)		01	LUTWB (1→0)	
	10	LUTWB (0→1)		10	LUTBW (0→1)	
	11	LUTBB (1→1)		11	LUTWW (1→1)	

CDI[3:0]: Vcom and data interval

CDI[3:0]	Vcom and Data Interval	CDI[3:0]	Vcom and Data Interval
0000 b	17 hsync	0110	11
0001	16	0111	10 (Default)
0010	15
0011	14	1101	4
0100	13	1110	3
0101	12	1111	2



(27) Low Power Detection (LPD) (R51H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Detect Low Power	0	0	0	1	0	1	0	0	0	1
	1	1	-	-	-	-	-	-	-	LPD

This command indicates the input power condition. Host can read this flag to learn the battery condition.

LPD: Interval Low Power Detection Flag

0: Low power input (VDD < 2.5V) 1: Normal status (default)

Product Specification

(28) TCON Setting (TCON) (R60H)

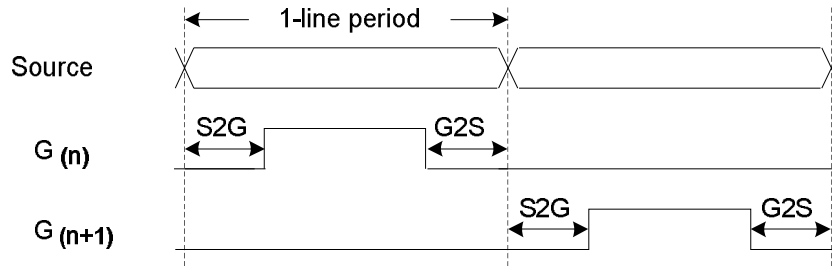
Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Set Gate/Source Non-overlap Period	0	0	0	1	0	1	0	0	0	0
	0	1	S2G[3:0]				G2S[3:0]			

This command defines non-overlap period of Gate and Source.

S2G[3:0] or G2S[3:0]: Source to Gate / Gate to Source Non-overlap period

S2G[3:0] or G2S[3:0]	Period	S2G[3:0] or G2S[3:0]	Period
0000b	4
0001	8	1011	48
0010	12(Default)	1100	52
0011	16	1101	56
0100	20	1110	60
0101	24	1111	64

Period = 660 nS.



(29) Resolution Setting (R61H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Set Display Resolution Action	0	0	0	1	1	0	0	0	0	1
	0	1	-	-	-	-	-	-	-	HRES[8]
	0	1	HRES[7:1]							-
	0	1	-	-	-	-	-	-	-	VRES[8]
	0	1	VRES[7:0]							

This command defines alternative resolution and this setting is of higher priority than the RES[1:0] in R00H (PSR).

HRES[8:1]: Horizontal Display Resolution

VRES[8:0]: Vertical Display Resolution

Channel disable calculation:

GD: First G active = G0; LAST active GD= first active +VRES [7:0] -1

SD: First active channel =S0; LAST active SD= first active +HRES [8:1]*2-1

(30) Source & gate start setting(R62H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Source & gate start setting	0	0	0	1	1	0	0	0	0	1
	0	1	-	-	-	-	-	-	-	S_start[8]
	0	1	S_start[7]	S_start[6]	S_start[5]	S_start[4]	S_start[3]	S_start[2]	S_start[1]	S_start[0]
	0	1	-	-	-	gscan	-	-	-	G_start[8]
	0	1	G_start[7]	G_start[6]	G_start[5]	G_start[4]	G_start[3]	G_start[2]	G_start[1]	G_start[0]

Product Specification

1. S_Start [8:0]: which source output line is the first data line
2. G_Start[8:0]: which gate line is the first scan line
3. gscan: Gate scan select
 - 0: Normal scan
 - 1: Cascade type 2 scan

(31) Get status (R71H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Read Flags	0	0	0	1	1	1	0	0	0	1
	1	1	-	-	I ² C_ERR	I ² C_BUSY_N	Data_flag	PON	POF	BUSY_N

This command reads the IC status.

I²C_ERR: I²C master error status.

I²C_BUSY_N: I²C master BUSY_N status (low active)

Data_flag: Driver has already received all the one frame data.

PON: 0: Not in PON mode. 1: In PON mode.

POF: 0: Not in POF mode. 1: In POF mode.

BUSY_N: Driver BUSY_N status (low active)

(32) Auto Measure Vcom (AMV) (R80H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Automatically measure Vcom	0	0	1	0	0	0	0	0	0	0
	0	1	-	-	AMVT[1:0]	XON	AMVS	AMV	AMVE	

This command reads the IC status.

AMVT[1:0]: Auto Measure Vcom Time

00b: 3s

01b: 5s (Default)

10b: 8s

11b: 10s

XON: All Gate ON of AMV

0: Gate normally scan during Auto Measure VCOM period. (default)

1: All Gate ON during Auto Measure VCOM period.

AMVS: Source output of AMV

0: Source output 0V during Auto Measure VCOM period. (default)

1: Source output VDHR during Auto Measure VCOM period.

AMV: Analog signal

0: Get Vcom value with the VV command (R81h) (default)

1: Get Vcom value in analog signal. (External analog to digital converter)

AMVE: Auto Measure Vcom Enable (Disable)

0: Auto measure VCOM disable (default)

1: Auto measure VCOM enable

(33) Vcom Value (VV) (R81H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Automatically measure Vcom	0	0	1	0	0	0	0	0	0	1
	1	1	-	VV[6:0]						

Product Specification

This command gets the Vcom value.

VV[5:0]: Vcom Value Output

VV[5:0]	Vcom value
000 0000b	-0.10 V
000 0001b	-0.15 V
000 0010b	-0.20 V
⋮	⋮
100 1110b	-4.00 V

(34) VCOM-DC Setting (R82H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Set VCM_DC	0	0	1	0	0	0	0	0	1	0
	0	1	-	VDCS[6:0]						

This command sets VCOM_DC value.

VDCS[5:0]: VCOM_DC Setting

VDCS[6:0]	VCOM_DC Value
000 0000b	-0.1V(default)
000 0001b	-0.15V
000 0010b	-0.2v
⋮	⋮
100 1110b	-4.0v

(35) Program Mode (PGM) (RA0H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Enter Program	0	0	1	0	1	0	0	0	0	0
Mode	0	1	1	0	1	0	0	1	0	1

After this command is issued, the chip would enter the program mode.

The mode would return to standby by hardware reset.

The only one parameter is a check code, the command would be executed if check code = 0xA5.

(36) Active Program (APG) (RA1H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Active Program OTP	0	0	1	0	1	0	0	0	0	1

After this command is issued, the chip would enter the program mode.

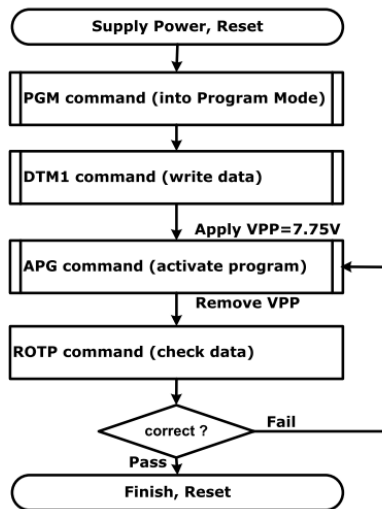
Product Specification

(37) Read OTP Data (ROTP) (RA2H)

Action	W/R	C/D	D7	D6	D5	D4	D3	D2	D1	D0
Read OTP data for check	0	0	1	0	1	0	0	0	1	0
	1	1	Dummy							
	1	1	The data of address 0x000 in the OTP							
	1	1	The data of address 0x001 in the OTP							
	1	1	..							
	1	1	The data of address (n-1) in the OTP							
	1	1	The data of address (n) in the OTP							

The command is used for reading the content of OTP for checking the data of programming.

The value of (n) is depending on the amount of programmed data, the max address = 0xFFE.



The sequence of programming OTP